

# Technical data sheet



Product: 583

Manufacturer: 3M DEUTSCHLAND GMBH

Product group: KLEBEBAND

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## 3M™ THERMAL BONDING FILM 583

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## 3M™ Thermal Bonding Film 583

### Product Description

3M™ Thermal Bonding Film 583 is a high strength, flexible, nitrile phenolic based thermoplastic bonding film. The product should be activated for bonding using a primary heating source and can be crosslinked (after bonding) by post-heating bonded parts for an extended time period at elevated temperature. Crosslinking provides additional heat and solvent resistance.

### Key Features

- Flexible
- Heat Activated
- Die Cuttable
- High Adhesion
- Heat Crosslinkable Option

### Product Construction/Material Description

**Note:** The following technical information and data is based upon limited 3M testing conditions and should not be used for specification purposes.

50 µm PET Release Liner

50 µm Adhesive

3M™ Thermal Bonding Film 583	
Property	Value
Base Adhesive	Nitrile Phenolic
Adhesive Thickness	2.0 mils (50.8µm)
Adhesive Tack	Slightly tacky
Adhesive Color	Hazy (Transparent)
Liner	Clear PET 2.0 mils (50.8µm)

### Typical Applications

The 3M film 583 can be used to bond together a wide variety of similar and dissimilar materials. Some application ideas include:

- Bonding metals, plastics, rubbers, fabrics
- Metal-to-metal, metal-to-fabrics, rubber-to-metal, metal-to-plastic
- Please work with your 3M Application Engineer to discuss other potential joining and bonding applications.

# 3M™ Thermal Bonding Film 583

## Application Equipment Suggestions

**Note:** Appropriate application equipment can enhance bonding film performance. We suggest the following equipment, but user applications vary depending on purpose and method of application.

The type of application equipment that can be used to bond 3M™ Thermal Bonding Film 583 will depend on the application involved and on the type of equipment available to the user. Thin films and flexible substrates can be bonded using a heated roll laminator where heat and pressure can be varied to suit the application. Larger, thicker substrates can be bonded using a heated static press or, in some cases, an autoclave. For applications where a shaped adhesive is bonded to a flat or three-dimensional part, a hot shoe or thermode method may be appropriate.

**The optimum bonding conditions should be predetermined by the end user with substrates specific to their application and the bonding method they chose.**

## Directions For Use – Heat Activation (Bonding)

3M™ Thermal Bonding Film 583 can typically be “heat stacked” (pre-tacked) onto one substrate by heating the adhesive at low heat and pressure to achieve a partial bond to the substrate. After heat stacking the adhesive to the first substrate, remove the product’s liner and then place the second substrate atop the surface of the heat stacked adhesive. Next, align the parts and place them into the bonding apparatus and adjoin the components using your final bonding protocol. Final bonds are made by heating the two substrates together under pressure with a heated press, a hot roll laminator, a hot shoe thermode or similar equipment. Note: Pre-tacking can help facilitate easier liner removal. Results may vary depending on end user’s skill and experience when working with heat activation bonding.

### **Suggested TACKING Conditions**

38°C to 90°C (100°F to 194°F) bondline temperature

2 - 5 seconds dwell time (at bondline temperature)

5 - 40 psi pressure

For optimum bonding, heat, pressure, and dwell time for using 3M film 583 will depend on the substrate type and thickness being bonded. A suggested starting point for bonding is described on the next page.

## 3M™ Thermal Bonding Film 583

### Suggested **BEGINNING** Bonding Conditions

107°C to 149°C (225°F to 300°F) bondline temperature

2 - 10 seconds dwell time (at bondline temperature)

15 - 40 psi pressure

### Directions for Use – Bonding Optimization

One approach to obtaining optimum bonding conditions is to evaluate a series of bonding temperatures, pressures and dwell times, and then evaluating bond performance to determine the best overall results. Evaluating a range of temperatures [e.g., 93°C (200°F), 107°C (225°F), 121°C (250°F), 135°C (275°F) or 149°C (300°F)], pressures (e.g., 10 psi, 15 psi or 20 psi) and dwell times (5 seconds, 10 seconds or 15 seconds) allows users to optimize or tune conditions that best suit their application needs. Substrate type(s), thickness and heat capacity will play a role in determining optimum bonding conditions. Thicker substrates and surfaces that may be more difficult to bond could require longer times, higher pressures, and higher temperatures than mentioned herein. **If voids are experienced in the bondline, they can be minimized by increasing pressure.**

**Note:** Once a bond is made, the bondline should be allowed to cool before stress is applied to the bond. Generally, cooling the bondline below 66°C (150°F) is adequate to allow the bonded parts to be unfixtured/unclamped and handled. Results may vary depending on end user's skill and experience when working in bonding applications.

### Directions for Use – Post Crosslinking

3M™ Thermal Bonding Film 583 may also be lightly crosslinked to enhance shear performance. Crosslinking of the 3M film 583 can typically be achieved by heating bond(s) between 105°C (302°F) to 177°C (350°F) for extended periods.

**Note:** The amount of crosslinking achieved via heating is temperature and time dependent. 3M™ Thermal Bonding Film 583 will achieve its highest degree of curing after an extended time (e.g., 8 to 15 minutes) at 177°C (350°F) or higher, however, an increase in adhesive internal strength can also be realized by holding bonded parts at much lower temperature for extended times. As an example, curing (crosslinking) of 3M™ Thermal Bonding Film 583 can be achieved by post-heating bonded parts isothermal at a temperature of 110°C (or greater) for 4 to 15 hrs. Again, the degree to which the adhesive crosslinks is directly proportional to its exposure time at a given temperature. **It is the user's responsibility to determine the optimal degree of crosslinking required for a given application.** Results may vary depending on end user's skill and experience when working with crosslinking and bonding.

# 3M™ Thermal Bonding Film 583

## Typical Physical Properties and Performance Characteristics

**Note:** The following technical information and data should be considered representative or typical only and should not be used for specification purposes. Final product specifications and testing methods will be outlined in the product's Certificate of Analysis (COA) that is shipped with the commercialized product.

3M™ Thermal Bonding Film 583			
Property	Test Method <sup>1</sup>	Value	
T-Peel Adhesion @ RT, 24 hr dwell <sup>2</sup>	ASTM D1876	Alum (etched)	2.25 N/mm
180 Degree Peel Adhesion @ RT 72 hr dwell <sup>3,4</sup>	ASTM D3330	SS	2.88 N/mm
		PC	3.69 N/mm
		ABS	3.61 N/mm
		Alum (etched)	3.07 N/mm
		FR4	3.31 N/mm
180 Degree Peel Adhesion @ 65°C/90% RH, 72 hr dwell <sup>3,4</sup>	ASTM D3330	SS	3.35 N/mm
180 Degree Peel Adhesion @ 85°C, 72 hr dwell <sup>3,4</sup>		SS	>3.00 N/mm
Static Shear <sup>5</sup>	ASTM D3654	Minutes	
1kg RT (Uncured)			>10,000
1kg 70°C (Cured)			>10,000
Overlap <sup>6</sup> Shear Strength @ RT	ASTM D1002		2.93 MPa (Uncured) 6.53 MPa (Fast Cure) 9.92 MPa (Slow Cure)
Glass Transition Temperature (Peak at tan delta)	Shear Parallel Plate DMA (1Hz 1% strain)		31°C (Uncured) 63°C (Cured)
Dielectric Constant <sup>7</sup> @ 1kHz	ASTM D-150		5.83 (Uncured) 5.19 (Cured)
Dissipation Factor <sup>7</sup> 1kHz	ASTM D-150		0.086 (Uncured) 0.058 (Cured)
Dielectric Breakdown <sup>7</sup> Voltage	ASTM D-149		4.41 kV (Uncured) 5.20 kV (Cured)
Dielectric Breakdown Strength <sup>7</sup>	ASTM D-149		77.8 kV/mm (Uncured) 99.4 kV/mm (Cured)
Surface Resistivity <sup>7</sup>	ASTM D-257		8.20E+13 ohm/sq (Uncured) 1.10E+15 ohm/sq (Cured)
Volume Resistivity <sup>7</sup>	ASTM D-257		1.10E+12 ohms/cm (Uncured) 1.30E+13 ohms/cm (Cured)

1. Methods listed as ASTM are tested in accordance with the ASTM method noted

2. T-Peel bonds were 0.5" wide using 10 mil etched aluminum bonded to each other; Peel rates were 12"/minute; Bonds were made at 149°C (300°F), 20 psi with a 15 second ramp time and heating from both sides

3. 180° peel bonds were 0.5" wide using 4 mil primed aluminum; Peel rates were 12"/minute; All 180° peel bonds were made using 140°C (284°F), 20 psi with a 15 second ramp time and heating from one side (metal) only

4. 4 mil aluminum coupons were pre-cleaned with MEK and heptane, and then primed with 3M™ Chemical-Resistant Tape Primer CR-100A

5. Static shear bonds were 1" x 1" using 4 mil primed aluminum against stainless steel with a 1-kg load; Static shear samples were bonded at 140°C (284°F), 70 psi and a 20 second ramp time and heating from one side (metal) only; 70°C static shear samples were post-cured by subjecting them to an 8-minute isothermal cure at 177°C (350°F) after heat bonding

6. OLS bonds were 1" x 0.5" on etched aluminum; pull rate was 0.2"/minute; All bonds were made using 140°C (284°F), 20 psi with 30 seconds of ramp time; Fast Curing = 8 minute post-curing cycle at 177°C (350°F); Slow Curing = 15 hour post-curing cycle at 110°C

7. All cured films were subjected to 8 minutes at 177°C (350°F) cure cycle prior to being tested

# 3M™ Thermal Bonding Film 583

## Storage and Shelf Life

3M™ Thermal Bonding Film 583 should be stored at or below 4°C (40°F) for maximum storage life. Higher storage temperatures reduce normal storage life.

Shelf life is 6 months from date of manufacturing when stored at 23°C (75°F), and 18 months from date of manufacturing when stored at 4°C (40°F).

## Certificate of Analysis (COA)

The 3M Certificate of Analysis (COA) for this product is established when the product is manufactured and deemed commercially available from 3M. The COA contains the 3M test methods, specifications limits and test results for the product's performance attributes that the product will be supplied against. Contact your local 3M representative for this product's COA.

# 3M™ Thermal Bonding Film 583

**Safety Data Sheet:** Review product Safety Data Sheet before use.

**Regulatory:** For regulatory information about this product, contact your 3M representative.

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